

DZ2424000L

Zener Diode DZ2424000L

Unit: mm

Silicon epitaxial planar type

For constant voltage / For surge absorption circuit Capability of withstanding a high surge type DZ2W240 in Power type package

Features

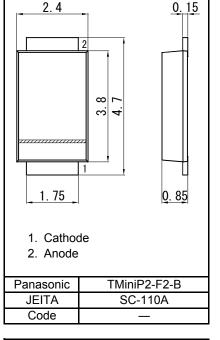
- · Excellent rising characteristics of zener current Iz
- Low zener operating resistance Rz
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: DG

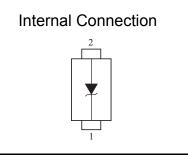
*2 t = 0.1ms

Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C							
Parameter	Symbol	Rating	Unit				
Repetitive peak forward current	IFRM	500	mA				
Forward current	IF	400	mA				
Total power dissipation ^{*1}	PT	2	W				
Non-repetitive reverse power surge *2	PZSM	100	W				
Electrostatic discharge *3	ESD	±30	kV				
Junction temperature	Tj	150	°C				
Operating ambient temperature	Topr	-40 to +85	°C				
Storage temperature	Tstg	-55 to +150	°C				
Note: *1 Mounted on ceramics print circuit board.							
Board size: 50 mm × 50 mm							
Board thickness: 0.8 mm							





*3 Test method:IEC61000_4_2(C = 150 pF,R = 330 Ω, Contact discharge:10 times)

■ Electrical Characteristics Ta = 25 °C ± 3 °C

Soldering size: 2 mm × 2 mm

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Forward voltage	VF	IF = 200 mA			1.2	V	
Zener voltage *1, *2	VZ	IZ = 10 mA	22.80	24.00	25.20	V	
Zener operating resistance	RZ	IZ = 10 mA			30	Ω	
Reverse current	IR	VR = 17.0 V			10	μA	
Temperature coefficient of zener voltage *3	SZ	IZ = 10 mA		24.0		mV/°C	
Nata) 4. Macauring matheda are based an IADANECE INDUCTORAL CTANDADD, US C 7024 Macauring matheda for Diadae							

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. Absolute frequency of input and output is 5 MHz.

3. *1 The temperature must be controlled 25°C for VZ mesurement.

VZ value measured at other temperature must be adjusted to VZ (25°C)

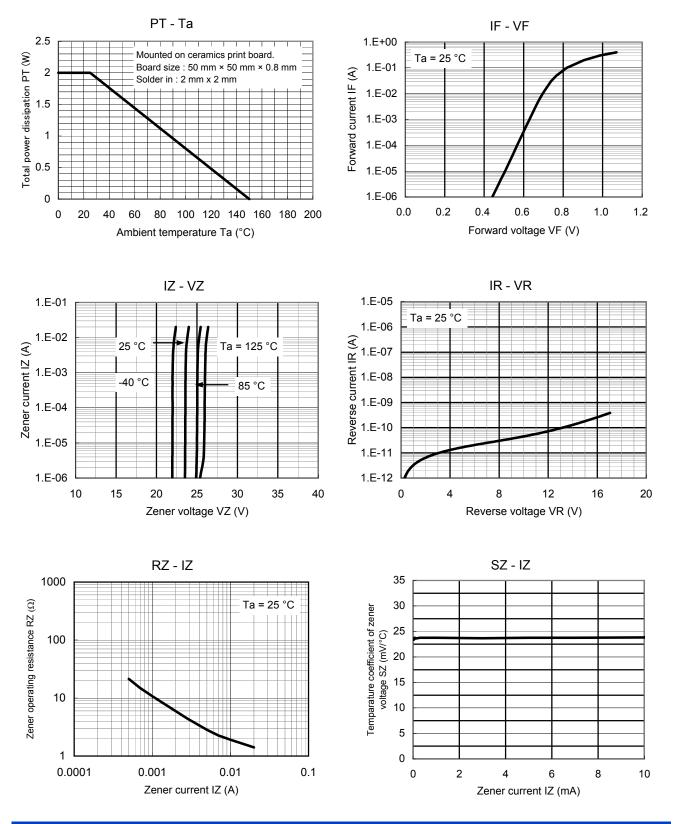
*2 VZ guaranted 20 ms after current flow.

*3 Tj = 25°C to 150°C



Zener Diode DZ2424000L

Technical Data (reference)



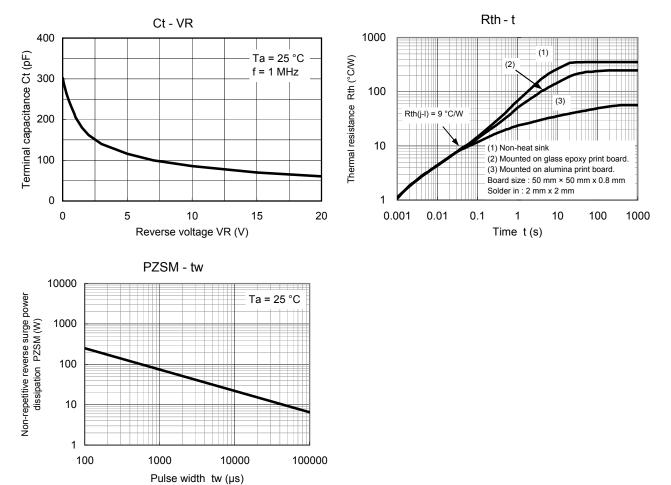
Page 2 of 4

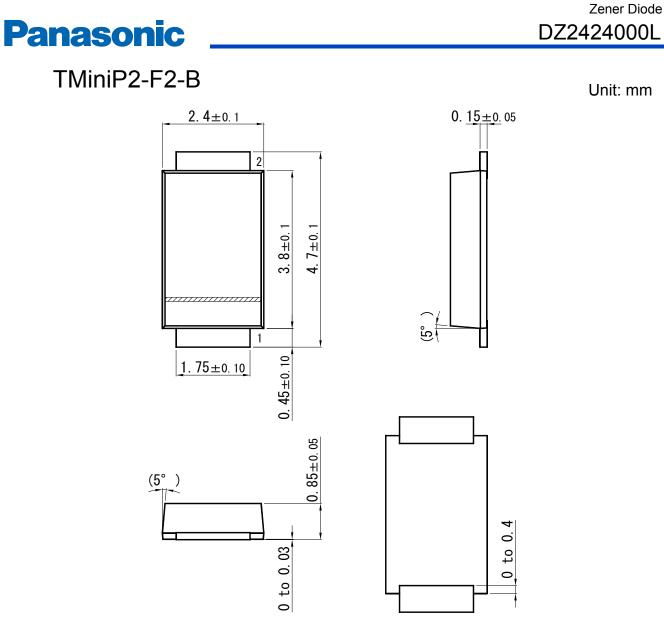
Established : 2011-09-09 Revised : 2013-05-13



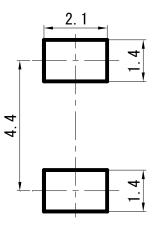
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Technical Data (reference)









Established : 2011-09-09 Revised : 2013-05-13

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